ZEISS Xradia 620 Versa Product Specifications



Imaging Specifications			
Spatial Resolution ^a (ZEISS Xradia Resolution Target)	0.5 μm		
Resolution at a Distance (RaaD™) ^{a,b} (at 50 mm working distance)	1.0 μm		
Minimum Achievable Voxel ^c (Voxel size at sample at maximum magnification)	40 nm		

X-ray Source			
Architecture	Sealed Transmission, Fast Activation		
Voltage Range	Spot size stable 30 – 160 kV		
Maximum Output	25 W		

X-ray Filters	
Automated Filter Changer (AFC)	24 filter capacity
X-ray Filters, Standard	Range of 12 filters
X-ray Filters, Custom	Available by special order

Contrast-Optimized Detectors					
	FPX	0.4X	4X	20X	40X
	Detector	Objective	Objective	Objective	Objective
	Optional	Standard	Standard	Standard	Optional
Spatial Resolution	12 μm	20 μm	1.9 μm	0.9 μm	0.5 μm
Max 3D Field of View (FOV)	140 mm	50 mm	6.5 mm	1.3 mm	645 μm
Wide Field Mode, Max 3D FOV		90 mm	11 mm		

Stages ^d	
Sample Stage, Load Capacity	25 kg
Sample Stage Travel, X, Y, Z	50 mm, 100 mm, 50 mm
Sample Stage Travel, Rotation	360°
Source Travel, Z-Direction	190 mm
Detector Travel, Z-Direction (Objectives)	290 mm
Detector Travel, Z-Direction (FPX Detector)	250 mm, 245 mm ^e

Notes

^a Spatial resolution measured with ZEISS Xradia 2D resolution target, normal field mode, optional 40x objective.

 $[^]b$ RaaD TM working distance defined as clearance around axis of rotation.

^c Voxel is a geometric term that contributes to but does not determine resolution, and is provided here only for comparison. ZEISS Xradia 620 Versa specifies resolution via spatial resolution, the true overall measurement of instrument resolution.

^d Z-direction is defined along the X-ray beam path.

^e FPX Z-stage travel when system is equipped with LabDCT.

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Advanced Capabilities	
DSCoVer (Dual-Scan Contrast Visualizer - Compositional contrast tool)	Standard
HART (High Aspect Ratio Tomography – Improved image quality and/or throughput for high aspect ratio samples)	Standard
WFM (Wide Field Mode – Wider lateral field of view)	Standard on 0.4X and 4X objectives
Vertical Stitching (Effective taller field of view by joining tomographies)	Standard
Python API (Integrated Python interface for user-scripted, specialized workflows to maximize productivity)	Standard
In Situ Control (Integrated in situ recipe control for Deben stage)	Standard
In Situ Interface Kit (Cable management and radiation safe pass-through hardware)	Optional
ZEISS LabDCT (Diffraction Contrast Tomography)	Optional
ZEISS FPX Flat Panel Extension (6MP large array detector for macroscopic imaging)	Optional
ZEISS Autoloader (14-sample automatic sample handler)	Optional
ZEISS OptiRecon (Iterative reconstruction for optimized tomographic imaging)	Optional
ZEISS ZEN Intellesis (Intelligent machine learning algorithms for image post-processing and segmentation)	Optional
ORS Dragonfly Pro (Advanced 3D visualization and analysis software)	Optional

Reconstruction (GPU-Accelerated)		
RaaD Objective Imaging (0.4X, 4X, 20X, 40X) (972 slices from 2000 projections, 2k x 2k)	< 2.2 min	
FPX Detector Imaging (2000 slices from 1301 projections, 3k x 2k)	< 10 min	

Charge-Coupled Device Detector		
Charge-Coupled Device, Pixel Array	2,048 x 2,048	
Charge-Coupled Device, Operating Temperature	< -50° C	
Charge-Coupled Device, Bit Depth	16 bits	

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System Control		
Instrument Software		
System Control & Tomography Acquisition	Scout-and-Scan™	
Reconstruction	XMReconstructor	
3D Viewer	XM3DViewer	
Workstation		
Operating System	Windows7 Pro	
Central Processing Unit (CPU)	Dual Ten Core CPU	
Graphics Processing Unit (GPU)	Dual CUDA-architecture GPU	
Hard Disk Physical Capacity	12 TB (3 x 4 TB), RAID-5	
Memory	32 GB, 128 GB (FPX Option)	
Display Monitor	24-inch LCD	

X-ray Radiation Safety			
Safety Standards Compliance	SEMI S2-1016b SEMI S8-1116 & S8-0712 EN/UL/IEC 61010-1-2010 (3rd edition) EN ISO13849-1:2008 NF C74-100		
Radiation Safety Measured 25 mm above surface of enclosure	< 1 μSv / hr		

LabDCT (optional module)			
Crystal symmetries ^f	Cubic		
	Hexagonal		
Minimum detectable grain size	40 μm		
Maximum sample sizeg (diameter / height)	1.5 mm / 1.5 mm		
Angular resolution	±0.5°		
Maximum number of grainsh	500		
Typical reconstruction time ⁱ	10 min to 20 hours		

^f Requires known space group and lattice parameters; strain free samples

User selectable. Lower voxel resolution data can be reconstructed faster

FPX Flat Panel Detector (optional module)		
CMOS, Pixel Array	3,072 x 1,944	
CMOS, Operating Temperature	Ambient	
CMOS, Bit Depth	14 bits	
Single Field of View (diameter / height)	140 mm / 93 mm	
Maximum Field of View ⁱ (diameter / height)	140 mm / 165 mm	

[†] Maximum Field of View uses the Vertical Stitching software feature to extend the total reconstructed volume.

⁹ Sample dependent – small grain sizes requires diametrically smaller sample. Volume can be expanded by vertical stitching her scan volume. Volume can be expanded by vertical stitching

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Autoloader (optional module)		
Station Positions	14	
Maximum Sample Dimensions (diameter)	56 mm ^k (using standard sample holders)	
Maximum Sample Dimensions (height)	70 mm	
Sample Maximum Weight	1.5 kg	

^k For samples greater than 56 mm and up to 100 mm diameter, adjacent sample stations must be unoccupied. For example, at maximum sample diameter of 100 mm, a maximum of seven station positions are usable.

In Situ Interface Kit (optional module)		
Integrated sample stage cable management system	Standard	
Radiation-safe cable pass-through	~80 mm curved port diameter	
Adaptor plate for sample stage ¹	Standard	

For in situ environment cells provided by Deben UK Ltd. Adapter plates for other types of in situ cells are available by special order.

<i>In Situ</i> Environment Cells ^m (optional, Interface Kit required)		
Stage Type	Tensile/Compression	
	Tensile/Compression + Heat	
	Tensile/Compression + Heat/Cool	
Maximum Load	Up to 0.1/0.2/0.5/5 kN	
Load Rate	0.03-2 mm/min	
Load Accuracy	1% of full range scale	
Maximum Extension	10 mm	

^m In situ environment cells provided by Deben UK Ltd. The above table represents range of the portfolio specifications. Individual cells have specific range attributes. Other brands and types of in situ cells with different capabilities are available upon request.